

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	14	("5414293"   "5652463"   "5692296"   "5760467"   "5905301"   "5909057").PN. OR ("6232652").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/05/11 15:28
L3	9	("5889323"   "5893726"   "5909057"   "6054008"   "6057597"   "6232652"   "6300673"   "6313521"   "6335563").PN. OR ("6445062").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/05/11 15:34
L5	124	((substrate pcb board ) and (IC integrated adj circuit die chip semiconductor wafer) and (lid cover) and (tape sealant glue ahesive) and (pattern break hole )).clm.	US-PGPUB	OR	ON	2006/05/11 16:46
L6	73	(257/683).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:20
L7	2823	(257/778).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L8	754	(257/796).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L9	1566	(438/108).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L10	999	(438/124).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L11	896	(7 8 9 10 ) and ((substrate pcb board ) and (IC integrated adj circuit die chip semiconductor wafer) and (lid cover) and (tape sealant glue ahesive) and (pattern break hole ))	US-PGPUB; USPAT	OR	ON	2006/05/11 16:55
L12	402	11 and package.ab.	US-PGPUB; USPAT	OR	ON	2006/05/11 16:55